



DESCRIPTION

The ES1AW~ES1JW are available in SOD-123FL package

ORDERING INFORMATION

Package Type	Part Number
SOD-123FL	ES1AW
	ES1BW
	ES1CW
	ES1DW
	ES1EW
	ES1GW
	ES1JW
Note	SPQ: 3,000pcs/Reel
AiT provides all RoHS Compliant Products	

FEATURES

- Easy pick and place
- For surface mounted applications
- Low profile package
- Built-in strain relief
- Superfast recovery times for high efficiency
- Available in SOD-123FL package

MECHANICAL DATA

Case: SOD-123FL

Terminals: Solderable per MIL-STD-750,
Method 2026

Approx. Weight: 15mg 0.00053oz

PIN DESCRIPTION





ABSOLUTE MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Ratings at 25°C ambient temperature unless otherwise specified. Single phase, half wave, 60 Hz, resistive or inductive load. For capacitive load, derate current by 20%

Parameter	Symbol	ES1AW	ES1BW	ES1CW	ES1DW	ES1EW	ES1GW	ES1JW	Unit
Maximum Repetitive Peak Reverse Voltage	V_{RRM}	50	100	150	200	300	400	600	V
Maximum RMS Voltage	V_{RMS}	35	70	105	140	210	280	420	V
Maximum DC Blocking Voltage	V_{DC}	50	100	150	200	300	400	600	V
Maximum Average Forward Rectified Current at $T_C=125^\circ\text{C}$	$I_{F(AV)}$	1							A
Peak Forward Surge Current 8.3ms Single Half Sine Wave Superimposed on Rated Load	I_{FSM}	30							A
Maximum Forward Voltage at 1A	V_F	1				1.25		1.68	V
Maximum DC Reverse Current at Rated DC Blocking Voltage	I_R					5		100	uA
Typical Junction Capacitance at $V_R=4\text{V}$, $f=1\text{MHz}$	C_J	15							pF
Maximum Reverse Recovery Time ^{NOTE1}	t_{rr}	35							ns
Typical Thermal Resistance ^{NOTE2}	$R_{\theta JA}$	85							°C/W
Operating and Storage Temperature Range	$T_{J,}$ T_{STG}	-55 ~150							°C

NOTE1: Measured with $I_F = 0.5\text{ A}$, $I_R = 1\text{ A}$, $I_{rr} = 0.25\text{ A}$

NOTE2: P.C.B. mounted with 2.0" X 2.0" (5 X 5 cm) copper pad areas.



TYPICAL CHARACTERISTICS

Figure. 1 Reverse Recovery Time Characteristic and Test Circuit Diagram

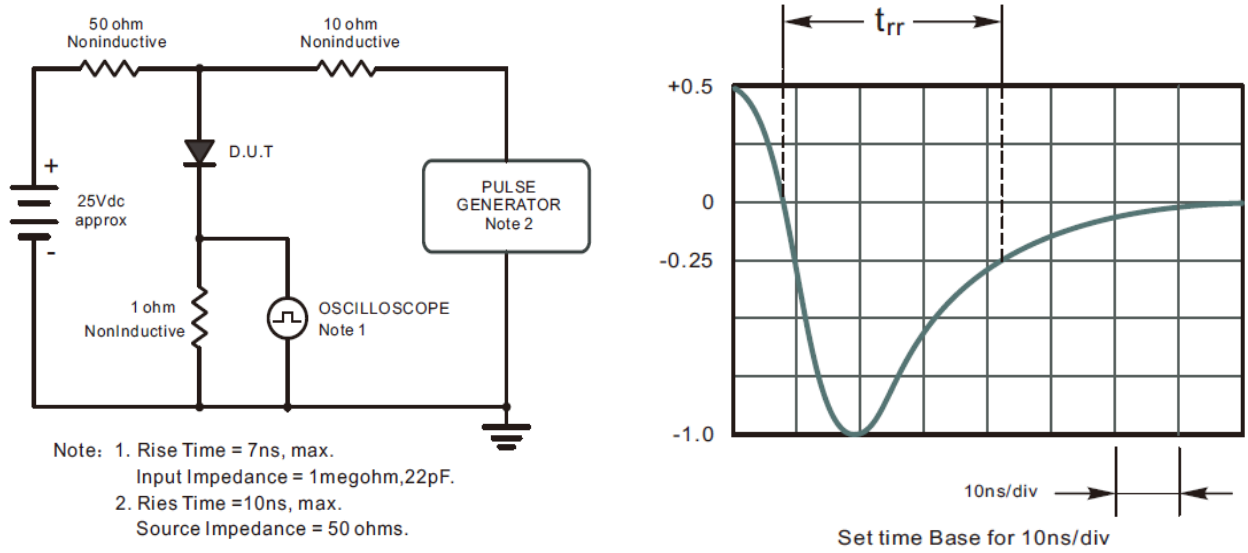


Figure. 2 Maximum Average Forward Current Rating

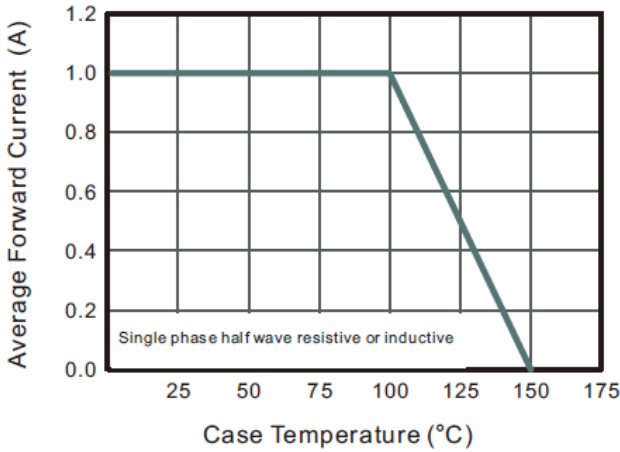


Figure. 3 Typical Reverse Characteristics

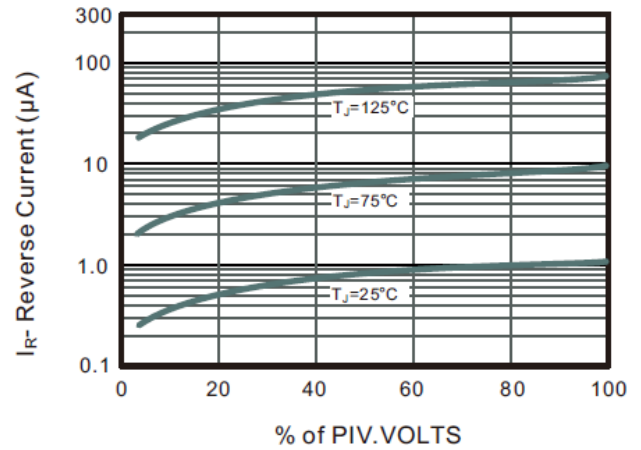




Figure. 4 Typical Forward Characteristics

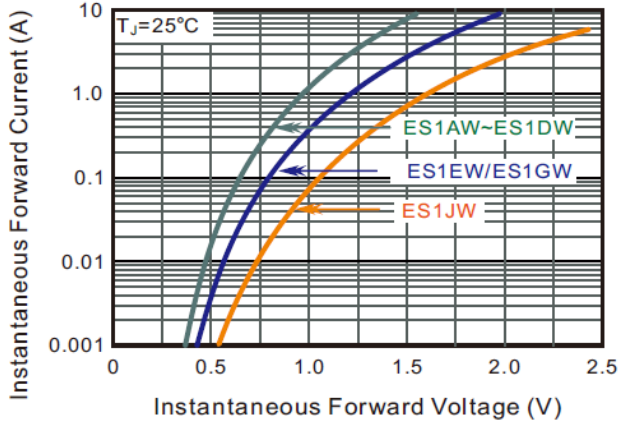


Figure. 5 Typical Junction Capacitance

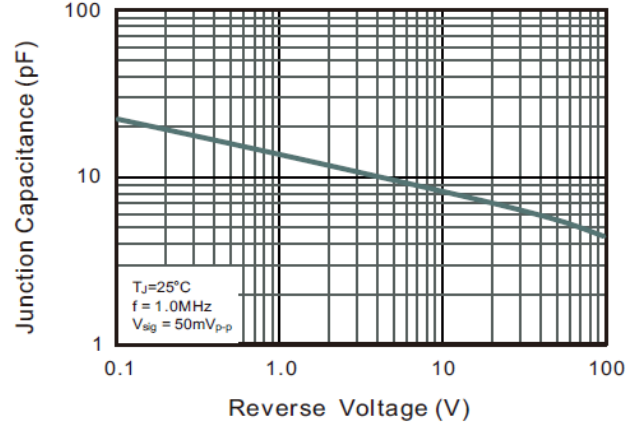
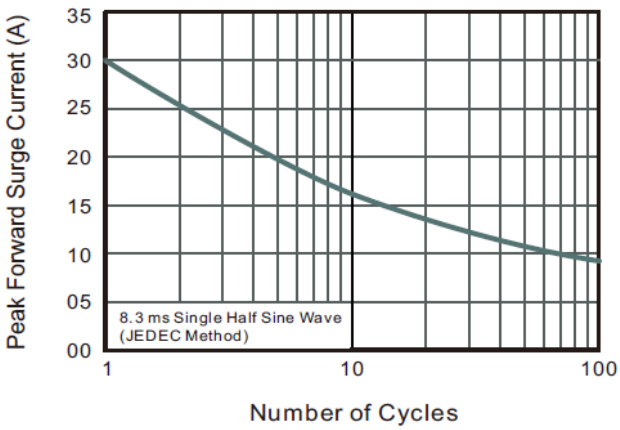


Figure. 6 Maximum Non-Repetitive Peak Forward Surge Current

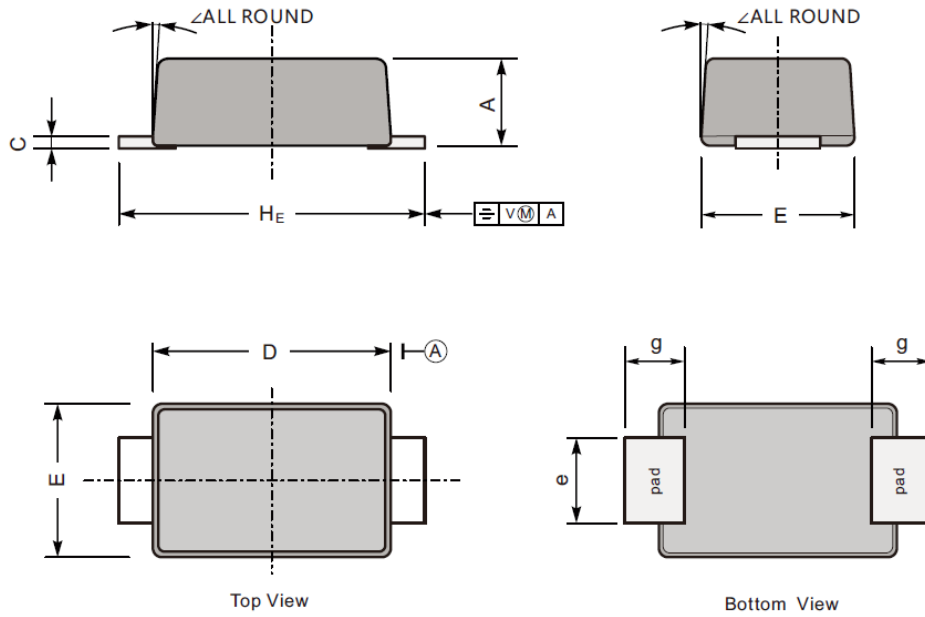




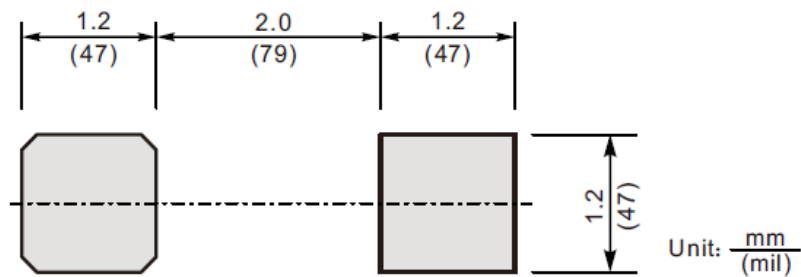
PACKAGE INFORMATION

Dimension in SOD-123FL(Unit: mm)

Plastic surface mounted package; 2 leads



The recommended mounting pad size



UNIT		A	C	D	E	e	g	H _E	∠
mm	Max	1.1	0.20	2.9	1.9	1.1	0.9	3.8	7°
	Min	0.9	0.12	2.6	1.7	0.8	0.7	3.5	
mil	Max	43	7.9	114	75	43	35	150	
	Min	35	4.7	102	67	31	28	138	



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